Features

- Fast read access time – 70ns
- Dual voltage range operation
  - Unregulated battery power supply range, 2.7V to 3.6V, or
  - Standard power supply range, 5V ± 10%
- Pin compatible with JEDEC standard Atmel® AT27C256R
- Low-power CMOS operation
  - 20µA max standby (less than 1µA, typical) for V_{CC} = 3.6V
  - 29mW max active at 5MHz for V_{CC} = 3.6V
- JEDEC standard surface mount package
  - 32-lead PLCC
- High-reliability CMOS technology
  - 2,000V ESD protection
  - 200mA latchup immunity
- Rapid programming algorithm – 100µs/byte (typical)
- CMOS- and TTL-compatible inputs and outputs
  - JEDEC standard for LVTTL and LVBO
- Integrated product identification code
- Industrial temperature range
- Green (Pb/halide-free) packaging option

256K (32K x 8) Unregulated Battery Voltage, High-speed, One-time Programmable, Read-only Memory

Atmel AT27BV256

1. Description

The Atmel AT27BV256 is a high-performance, low-power, low-voltage, 262,144-bit, one-time programmable, read-only memory (OTP EPROM) organized as 32K by 8 bits. It requires only one supply in the range of 2.7V to 3.6V in normal read mode operation, making it ideal for fast, portable systems using either regulated or unregulated battery power.

The Atmel innovative design techniques provide fast speeds that rival 5V parts, while keeping the low power consumption of a 3V supply. At V_{CC} = 2.7V, any word can be accessed in less than 70ns. With a typical power dissipation of only 18mW at 5 MHz and V_{CC} = 3V, the AT27BV256 consumes less than one-fifth the power of a standard, 5V EPROM.

Standby mode supply current is typically less than 1µA at 3V. The AT27BV256 simplifies system design and stretches battery lifetime even further by eliminating the need for power supply regulation.

The AT27BV256 is available in an industry-standard, JEDEC-approved ,one-time programmable (OTP) PLCC package. All devices feature two-line control ($\overline{CE}$, $\overline{OE}$) to give designers the flexibility to prevent bus contention.

The AT27BV256 operating with V_{CC} at 3.0V produces TTL-level outputs that are compatible with standard TTL logic devices operating at V_{CC} = 5.0V. At V_{CC} = 2.7V, the part is compatible with JEDEC-approved, low-voltage battery operation (LVBO) interface specifications. The device is also capable of standard, 5V operation, making it ideally suited for dual supply range systems or card products that are pluggable in both 3V and 5V hosts.

The AT27BV256 has additional features to ensure high quality and efficient production use. The rapid programming algorithm reduces the time required to program the part and guarantees reliable programming. Programming time is typically only 100µs/byte. The integrated product identification code electronically identifies the device and manufacturer.

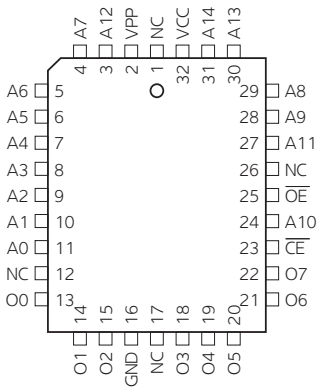
0601F–EPROM–4/11

This feature is used by industry-standard programming equipment to select the proper programming algorithms and voltages. The AT27BV256 programs in exactly the same way as a standard, 5V Atmel AT27C256R, and uses the same programming equipment.

2. Pin configurations

Pin name	Function
A0 - A14	Addresses
O0 - O7	Outputs
$\overline{CE}$	Chip enable
$\overline{OE}$	Output enable
NC	No connect

32-lead PLCC
Top view

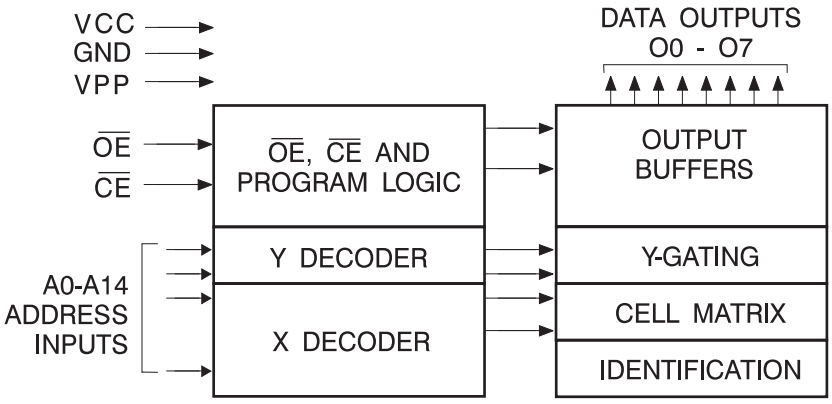


Note: PLCC package pins 1 and 17 are "don't connect."

3. System considerations

Switching between active and standby conditions via the chip enable pin may produce transient voltage excursions. Unless accommodated by the system design, these transients may exceed datasheet limits, resulting in device non-conformance. At a minimum, a 0.1µF, high-frequency, low inherent inductance, ceramic capacitor should be utilized for each device. This capacitor should be connected between the V_{CC} and ground terminals of the device, as close to the device as possible. Additionally, to stabilize the supply voltage level on printed circuit boards with large EPROM arrays, a 4.7µF bulk electrolytic capacitor should be utilized, again connected between the V_{CC} and ground terminals. This capacitor should be positioned as close as possible to the point where the power supply is connected to the array.

Figure 3-1. Block diagram



4. Absolute maximum ratings*

Temperature under bias	-40°C to +85°C
Storage temperature	-65°C to +125°C
Voltage on any pin with respect to ground	-2.0V to +7.0V (1)
Voltage on A9 with respect to ground	-2.0V to +14.0V (1)
V_{PP} supply voltage with respect to ground	-2.0V to +14.0V (1)

*NOTICE: Stresses beyond those listed under "Absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: 1. Minimum voltage is -0.6V DC, which may undershoot to -2.0V for pulses of less than 20ns. Maximum output pin voltage is V_{CC} + 0.75V DC, which may be exceeded if certain precautions are observed (consult application notes), and which may overshoot to +7.0V for pulses of less than 20ns.

5. DC and AC characterisitcs

Table 5-1. Operating modes

Mode/Pin	$\overline{CE}$	$\overline{OE}$	Ai	V_{PP}	V_{CC}	Outputs
Read (2)	V_{IL}	V_{IL}	Ai	V_{CC}	V_{CC}	D_{OUT}
Output disable (2)	V_{IL}	V_{IH}	X (1)	V_{CC}	V_{CC}	High Z
Standby (2)	V_{IH}	X	X	V_{CC}	V_{CC}	High Z
Rapid program (3)	V_{IL}	V_{IH}	Ai	V_{PP}	V_{CC}	D_{IN}
PGM verify (3)	X	V_{IL}	Ai	V_{PP}	V_{CC}	D_{OUT}
Optional PGM verify (3)	V_{IL}	V_{IL}	Ai	V_{CC}	V_{CC}	D_{OUT}
PGM inhibit (3)	V_{IH}	V_{IH}	X	V_{PP}	V_{CC}	High Z
Product identification (3)(5)	V_{IL}	V_{IL}	A9 = V_H (4) A0 = V_{IH} or V_{IL} A1 - A14 = V_{IL}	V_{CC}	V_{CC}	Identification code

Note: 1. X can be V_{IL} or V_{IH}.
2. Read, output disable, and standby modes require 2.7V ≤ V_{CC} ≤ 3.6V or 4.5V ≤ V_{CC} ≤ 5.5V.
3. Refer to programming characteristics. Programming modes require V_{CC} = 6.5V.
4. V_H = 12.0 ± 0.5V.
5. Two identifier bytes may be selected. All Ai inputs are held low (V_{IL}) except A9, which is set to V_H, and A0, which is toggled low (V_{IL}) to select the manufacturers' identification byte and high (V_{IH}) to select the device code byte.

Table 5-2. DC and AC operating conditions for read operation

	Atmel AT27BV256-70
Industrial operating temperature (case)	-40°C - 85°C
V_{CC} power supply	2.7V to 3.6V
	5V ± 10%

Table 5-3. DC and operating characteristics for read operation

Symbol	Parameter	Condition	Min	Max	Units
V_{CC} = 2.7V to 3.6V					
I_{LI}	Input load current	V_{IN} = 0V to V_{CC}		±1	µA
I_{LO}	Output leakage current	V_{OUT} = 0V to V_{CC}		±5	µA
I_{PP1} (2)	V_{PP} (1) read/standby current	V_{PP} = V_{CC}		10	µA
I_{SB}	V_{CC} (1) standby current	I_{SB1} (CMOS), $\overline{CE}$ = V_{CC} ± 0.3V		20	µA
		I_{SB2} (TTL), $\overline{CE}$ = 2.0 to V_{CC} + 0.5V		100	µA
I_{CC}	V_{CC} active current	f = 5MHz, I_{OUT} = 0mA, $\overline{CE}$ = V_{IL}, V_{CC} = 3.6V		8	mA
V_{IL}	Input low voltage	V_{CC} = 3.0 to 3.6V	-0.6	0.8	V
		V_{CC} = 2.7 to 3.6V	-0.6	0.2 x V_{CC}	V
V_{IH}	Input high voltage	V_{CC} = 3.0 to 3.6V	2.0	V_{CC} + 0.5	V
		V_{CC} = 2.7 to 3.6V	0.7 x V_{CC}	V_{CC} + 0.5	V
V_{OL}	Output low voltage	I_{OL} = 2.0mA		0.4	V
		I_{OL} = 100µA		0.2	V
		I_{OL} = 20µA		0.1	V
V_{OH}	Output high voltage	I_{OH} = -2.0mA	2.4		V
		I_{OH} = -100µA	V_{CC} - 0.2		V
		I_{OH} = -20µA	V_{CC} - 0.1		V
V_{CC} = 4.5V to 5.5V					
I_{LI}	Input load current	V_{IN} = 0V to V_{CC}		±1	µA
I_{LO}	Output leakage current	V_{OUT} = 0V to V_{CC}		±5	µA
I_{PP1} (2)	V_{PP} (1) read/standby current	V_{PP} = V_{CC}		10	µA
I_{SB}	V_{CC} (1) standby current	I_{SB1} (CMOS), $\overline{CE}$ = V_{CC} ± 0.3V		100	µA
		I_{SB2} (TTL), $\overline{CE}$ = 2.0 to V_{CC} + 0.5V		1	mA
I_{CC}	V_{CC} active current	f = 5MHz, I_{OUT} = 0mA, $\overline{CE}$ = V_{IL}		20	mA
V_{IL}	Input low voltage		-0.6	0.8	V
V_{IH}	Input high voltage		2.0	V_{CC} + 0.5	V
V_{OL}	Output low voltage	I_{OL} = 2.1mA		0.4	V
V_{OH}	Output high voltage	I_{OH} = -400µA	2.4		V

Notes: 1. V_{CC} must be applied simultaneously with or before V_{PP}, and removed simultaneously with or after V_{PP}.

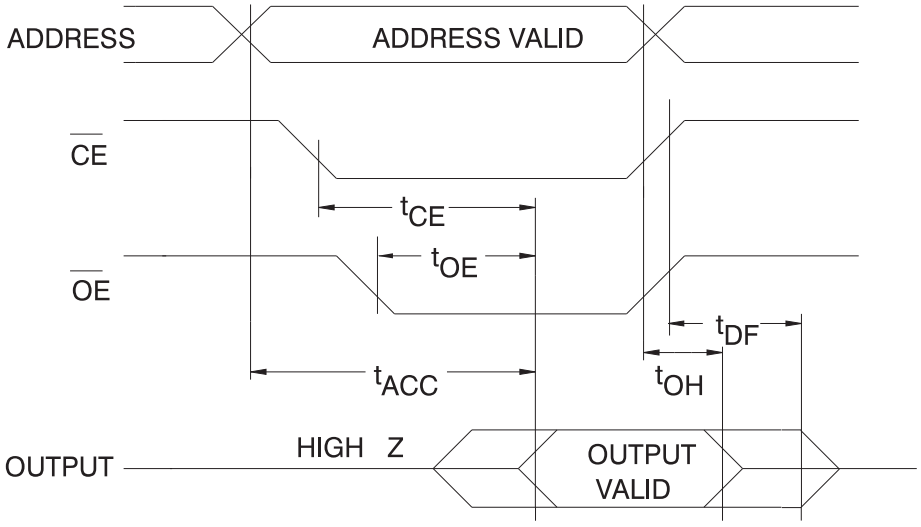
2. V_{PP} may be connected directly to V_{CC}, except during programming. The supply current would then be the sum of I_{CC} and I_{PP}.

Table 5-4. AC characteristics for read operation

V_{CC} = 2.7V to 3.6V and 4.5V to 5.5V

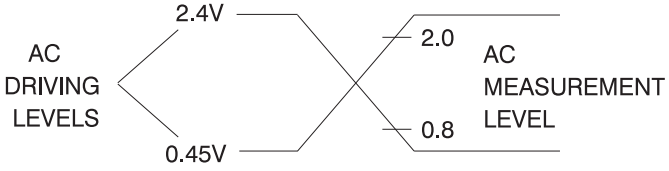
Symbol	Parameter	Condition	Atmel AT27BV256-70		Units
			Min	Max	
t_{ACC} (3)	Address to output delay	$\overline{CE}$ = $\overline{OE}$ = V_{IL}		70	ns
t_{CE} (2)	$\overline{CE}$ to output delay	$\overline{OE}$ = V_{IL}		70	ns
t_{OE} (2)(3)	$\overline{OE}$ to output delay	$\overline{CE}$ = V_{IL}		50	ns
t_{DF} (4)(5)	$\overline{OE}$ or $\overline{CE}$ High to output float, whichever occurred first			40	ns
t_{OH}	Output hold from address, $\overline{CE}$ or $\overline{OE}$, whichever occurred first		0		ns

Figure 5-1. AC waveforms for read operation (1)



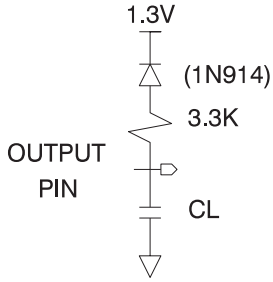
Notes:
1. Timing measurement references are 0.8V and 2.0V. Input AC drive levels are 0.45V and 2.4V, unless otherwise specified.
2. $\overline{OE}$ may be delayed up to t_{CE} - t_{OE} after the falling edge of $\overline{CE}$ without impact on t_{CE}.
3. $\overline{OE}$ may be delayed up to t_{ACC} - t_{OE} after the address is valid without impact on t_{ACC}.
4. This parameter is only sampled, and is not 100% tested.
5. Output float is defined as the point when data is no longer driven.
6. When reading an Atmel AT27BV256, a 0.1µF capacitor is required across V_{CC} and ground to suppress spurious voltage transients.

Figure 5-2. Input test waveform and measurement level



t_R, t_F < 20ns (10% to 90%)

Figure 5-3. Output test load



Note: CL = 100pF including jig capacitance.

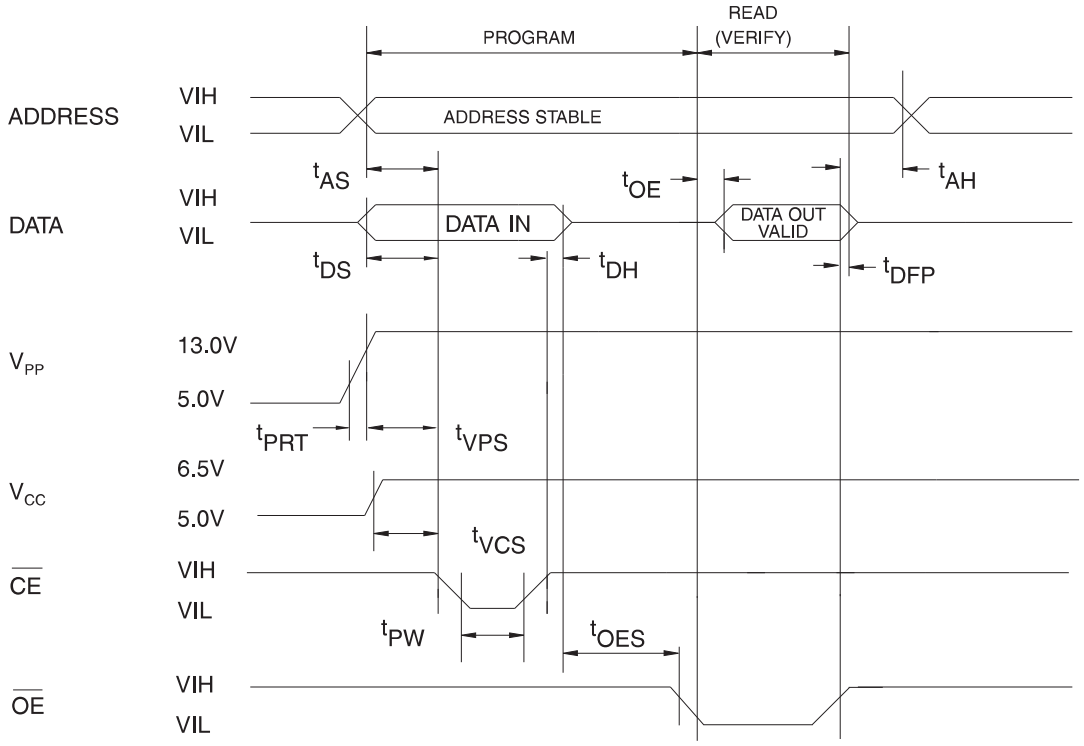
Table 5-5. Pin capacitance

f = 1MHz, T = 25°C[1]

Symbol	Typ	Max	Units	Conditions
C_{IN}	4	8	pF	V_{IN} = 0V
C_{OUT}	8	12	pF	V_{OUT} = 0V

Note: 1. Typical values for nominal supply voltage. This parameter is only sampled, and is not 100% tested.

Figure 5-4. Programming waveforms[1]



Notes: 1. The input timing reference is 0.8V for V_{IL} and 2.0V for V_{IH}.

2. t_{OE} and t_{DFP} are characteristics of the device, but must be accommodated by the programmer.

3. When programming the Atmel AT27BV256, a 0.1µF capacitor is required across V_{PP} and ground to suppress spurious voltage transients.

Table 5-6. DC programming characterisitcs

T_A = 25 ± 5°C, V_{CC} = 6.5 ± 0.25V, V_{PP} = 13.0 ± 0.25V

Symbol	Parameter	Test conditions	Limits		Units
			Min	Max	
I_{LI}	Input load current	$V_{IN} = V_{IL}, V_{IH}$		±10	µA
V_{IL}	Input low level		-0.6	0.8	V
V_{IH}	Input high level		2.0	V_{CC} + 0.5	V
V_{OL}	Output low voltage	I_{OL} = 2.1mA		0.4	V
V_{OH}	Output high voltage	I_{OH} = -400µA	2.4		V
I_{CC2}	V_{CC} supply current (program and verify)			25	mA
I_{PP2}	V_{PP} current	$\overline{CE} = V_{IL}$		25	mA
V_{ID}	A9 product identification voltage		11.5	12.5	V

Table 5-7. AC programming characteristics

T_A = 25 ± 5°C, V_{CC} = 6.5 ± 0.25V, V_{PP} = 13.0 ± 0.25V

Symbol	Parameter	Test conditions[1]	Limits		Units
			Min	Max	
t_{AS}	Address setup time	Input rise and fall times: (10% to 90%) 20 ns Input pulse levels: 0.45V to 2.4V Input timing reference level: 0.8V to 2.0V Output timing reference level: 0.8V to 2.0V	2		µs
t_{OES}	$\overline{OE}$ setup time		2		µs
t_{DS}	Data setup time		2		µs
t_{AH}	Address hold time		0		µs
t_{DH}	Data hold time		2		µs
t_{DFP}	$\overline{OE}$ high to output float delay[2]		0	130	ns
t_{VPS}	V_{PP} setup time		2		µs
t_{VCS}	V_{CC} setup time		2		µs
t_{PW}	$\overline{CE}$ program pulse width[3]		95	105	µs
t_{OE}	Data valid from $\overline{OE}$[2]			150	ns
t_{PRT}	V_{PP} pulse rise time during programming		50		ns

Notes:
1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously with or after V_{PP}.
2. This parameter is only sampled, and is not 100% tested. Output float is defined as the point where data is no longer driven. See timing diagram.
3. Program pulse width tolerance is 100µsec ± 5%.

Table 5-8. The Atmel AT27BV256 integrated product identification code[1]

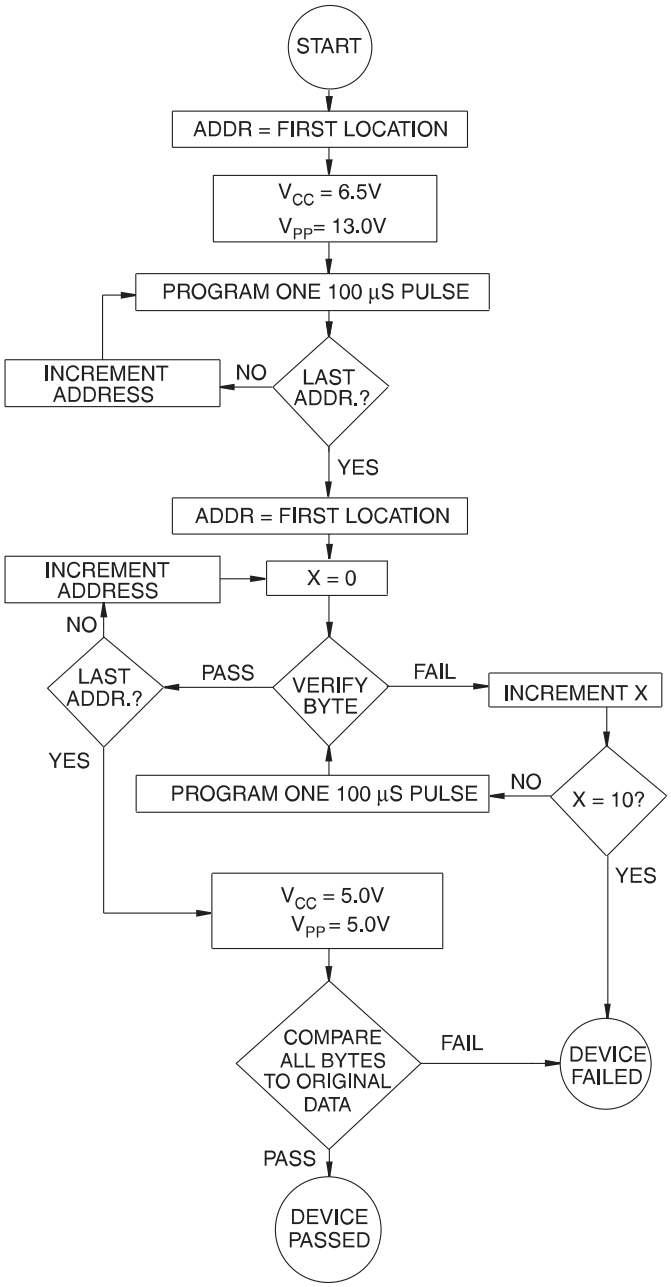
Codes	Pins									Hex data
	A0	O7	O6	O5	O4	O3	O2	O1	O0	
Manufacturer	0	0	0	0	1	1	1	1	0	1E
Device type	1	1	0	0	0	1	1	0	0	8C

Note: 1. The Atmel AT27BV256 has the same product identification code as the Atmel AT27C256R and Atmel AT27LV256A. They are all programming compatible

6. Rapid programming algorithm

A 100µs $\overline{CE}$ pulse width is used to program. The address is set to the first location. V_{CC} is raised to 6.5V and V_{PP} is raised to 13.0V. Each address is first programmed with one 100µs $\overline{CE}$ pulse without verification. Then a verification/reprogramming loop is executed for each address. In the event a byte fails to pass verification, up to 10 successive 100µs pulses are applied with a verification after each pulse. If the byte fails to verify after 10 pulses have been applied, the part is considered failed. After the byte verifies properly, the next address is selected until all have been checked. V_{PP} is then lowered to 5.0V and V_{CC} to 5.0V. All bytes are read again and compared with the original data to determine if the device passes or fails.

Figure 6-1. Rapid programming algorithm



7. Ordering Information

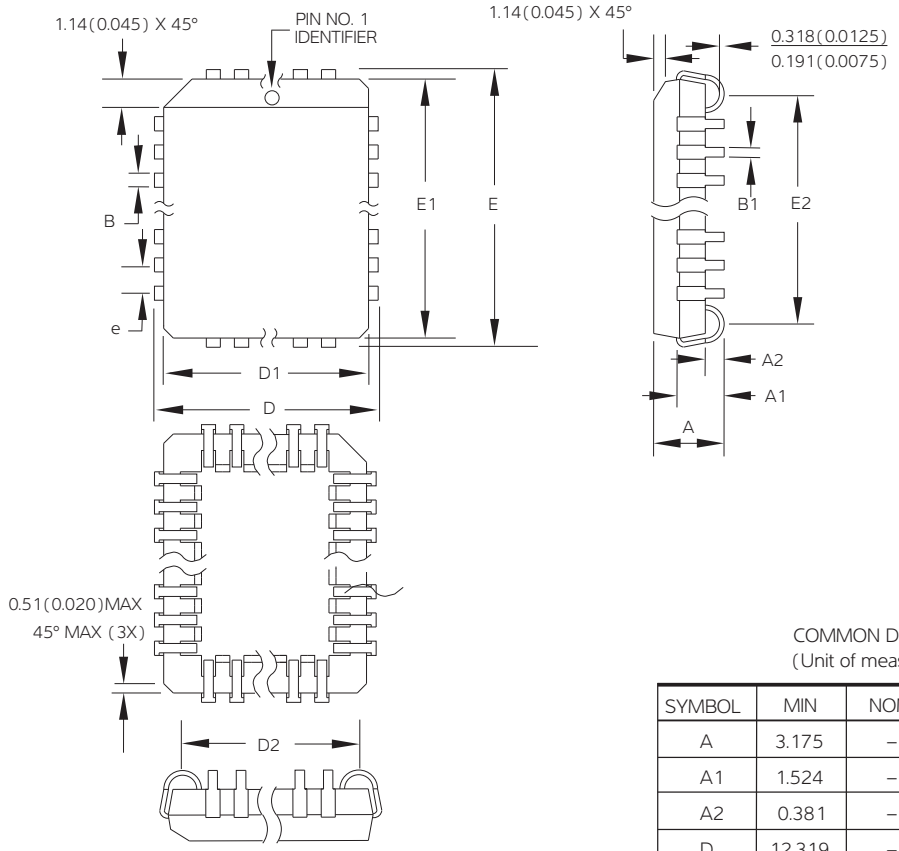
Green package option (Pb/hailde-free)

t_{ACC} (ns)	I_{CC} (mA)		Atmel Ordering Code	Lead finish	Package	Operation range
	Active	Standby				
70	8	0.02	AT27BV256-70JU	Matte tin	32J	Industrial (-40°C to 85°C)

Package type	
32J	32-lead, plastic, J-leaded chip carrier (PLCC)

8. Packaging Information

32J – PLCC



COMMON DIMENSIONS
(Unit of measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	3.175	–	3.556	
A1	1.524	–	2.413	
A2	0.381	–	–	
D	12.319	–	12.573	
D1	11.354	–	11.506	Note 2
D2	9.906	–	10.922	
E	14.859	–	15.113	
E1	13.894	–	14.046	Note 2
E2	12.471	–	13.487	
B	0.660	–	0.813	
B1	0.330	–	0.533	
e	1.270 TYP			

Notes:
1. This package conforms to JEDEC reference MS-016, Variation AE.
2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is .010"(0.254mm) per side. Dimension D1 and E1 include mold mismatch and are measured at the extreme material condition at the upper or lower parting line.
3. Lead coplanarity is 0.004" (0.10mm) maximum.

10/04/01

Package Drawing Contact: packagedrawings@atmel.com	TITLE	DRAWING NO.	REV.
	32J, 32-lead, Plastic J-leaded Chip Carrier (PLCC)	32J	B

9. Revision history

Doc. Rev.	Date	Comments
0601F	04/2011	Remove SOIC and TSOP packages Add lead finish to ordering information
0601E	12/2007	

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